



05-14-2004

ASSIGNMENT 102745473
-PATENTS ONLY-

EET

S.10.04

To: Honorable Commissioner of Patents and Trademarks:

Please record the attached original document(s) or copy thereof.

1. Name of conveying party(ies)
 - a) Dwight Cornwell
 - b) Douglas Johnson Werner
2. Name and address of receiving party(ies):
 - a) Name: Hitachi Global Storage Technologies Netherlands B.V.
Address: Locatellikade 1
Parnassustoren,
1076 AZ Amsterdam
The Netherlands
3. Nature of conveyance:

☒	Assignment	☐	Merger
☐	Security Agreement	☐	Change of Name
☐	Other _____	☐	License Agreement

Execution Date: April 26, 2004

4. Application Number(s) or Patent Number(s): 10/751,807

The title of the (new) application is: _____

IMAGE TRANSFER PROCESS FOR THIN FILM COMPONENT DEFINITION

5. Please send all correspondence concerning this (these) documents to:

Silicon Valley IP Group, PC
P.O. Box 721120
San Jose, CA 95172-1120
Tel. No.: (408) 971-2573

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 3.41): \$40.00

☐	Enclosed
☒	Authorized to be charged to Deposit Account No. 50-2587 (Order No.: HIT1P062/HSJ920030264US1).

8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: _____

5/4/04


Dominic M. Kotab
Registration No. 42,762

05/13/2004 LMUELLER 00000041 502587 10751807

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40.00 DA

Attorney Docket No. HIT1P062/HSJ920030264US1

(Revised 01/96)

PATENT
REEL: 015313 FRAME: 0674

ASSIGNMENT OF PATENT APPLICATION

(Accompanying Application)

Whereas I/we the undersigned inventor(s) have invented certain new and useful improvements as set forth in the patent application entitled:

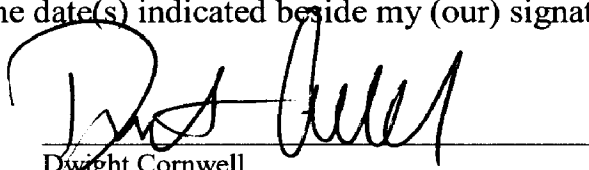
IMAGE TRANSFER PROCESS FOR THIN FILM COMPONENT DEFINITION

(Atty. Docket No.: HIT1P062/HSJ9-2003-0264US1) for which I (we) have executed an application for a United States Letters Patent.

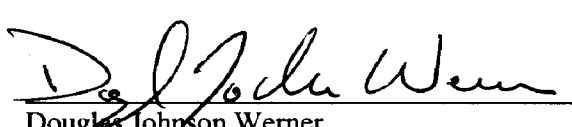
For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we the undersigned inventor(s) hereby:

- 1) Sell(s), assign(s) and transfer(s) to **Hitachi Global Storage Technologies Netherlands B.V.**, a corporation having a place of business at Locatellikade 1, Parnassustoren, 1076 AZ Amsterdam, The Netherlands, (hereinafter referred to as "ASSIGNEE"), the entire right title and interest in any and all improvements and inventions disclosed in, application(s) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed in the above referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division(s), continuation(s), substitutes(s) or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I/we have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signed on the date(s) indicated beside my (our) signature(s).

1) Signature: 
Typed Name: Dwight Cornwell

Date: 4-26-04

2) Signature: 
Typed Name: Douglas Johnson Werner

Date: 4-26-04